



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q76697

Yoichiro KURITA, et al.

Appln. No.: 10/626.522

Group Art Unit: 2814

Confirmation No.: 1128

Examiner: Nathan W. HA

Filed: July 25, 2003

For: BONDING METHOD AND BONDING APPARATUS

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated December 15, 2004 in which the Examiner has required a restriction, Applicant responds by electing Group I, *i.e.*, claims 1-6, drawn to a bonding apparatus for a semiconductor device. This election is made without prejudice to the filing of a divisional application directed to the non-elected claims.

Prompt and favorable action on the elected claims is now respectfully requested.

Respectfully submitted,

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